MARKING DIAGRAMS

Low-Voltage CMOS Quad 2-Input NOR Gate

With 5 V-Tolerant Inputs

MC74LCX02

The MC74LCX02 is a high performance, quad 2-input NOR gate operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows MC74LCX02 inputs to be safely driven from 5 V devices.

Features

- Designed for 1.65 V to 5.5 V V_{CC} Operation
- 5 V Tolerant Inputs Interface Capability With 5 V TTL Logic
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability @ 3.0 V
- Near Zero Static Supply Current (10 µA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 100 mA
- ESD Performance: Human Body Model >2000 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

PIN NAMES

Pins	Function
An, Bn	Data Inputs
On	Outputs

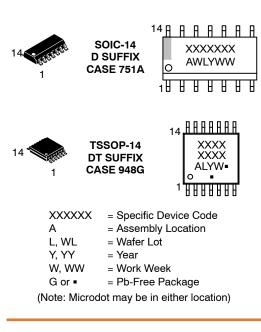
TRUTH TABLE

Inputs		Outputs		
An	Bn	Ōn		
L	L	Н		
Н	н	L		
Н	L	L		
Н	Н	L		

H = High Voltage Level

L = Low Voltage Level

For I_{CC} reasons, DO NOT FLOAT Inputs



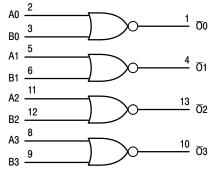
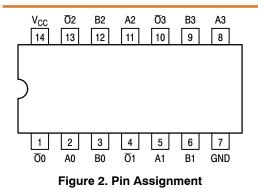


Figure 1. Logic Diagram



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

MAXIMUM RATINGS

Symbol	Param	Value	Unit	
V _{CC}	DC Supply Voltage		–0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		–0.5 to +6.5	V
Vo	DC Output Voltage (Note 1)	Active-Mode (High or Low State) Tri-State Mode Power-Down Mode (V _{CC} = 0 V)	-0.5 to V _{CC} + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Grou	nd Pin	±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10	secs	260	°C
ТJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 1)	SOIC-14 QFN14 TSSOP-14	116 130 150	°C/W
P _D	Power Dissipation in Still Air at 125°C	SOIC-14 QFN14 TSSOP-14	1077 962 833	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating Oxygen Index: 28 to 3	4	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. I_O absolute maximum rating must be observed.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol		Min	Тур	Max	Unit	
V _{CC}	Supply Voltage	1.65	3.3	5.5	V	
		Data Retention Only	1.5	3.3	5.5	
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State)	0	-	V _{CC}	V
		Tri-State Mode	0	-	5.5	
		Power Down Mode ($V_{CC} = 0 V$)	0	-	5.5	
T _A	Operating Free-Air Tempe	rature	-40	-	+125	°C
t _r , t _f	Input Rise or Fall Rate	V _{CC} = 1.65 V to 1.95 V	0	-	20	nS/V
		V _{CC} = 2.3 V to 2.7 V	0	-	20	
		V_{I} from 0.8 V to 2.0 V, V_{CC} = 3.0 V	0	-	10	
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	0	-	5	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

	Parameter			T _A = -40 °C to +85 °C		$T_A = -40 \ ^\circ C$ to +125 $^\circ C$			
Symbol		Conditions	V _{CC} (V)	Min	Max	Min	Max	Unit	
V _{IH}	HIGH Level Input Voltage		1.65–1.95	0.65 x V _{CC}	-	0.65 x V _{CC}	_	V	
			2.3–2.7	1.7	-	1.7	-		
			3.0-3.6	2.0	-	2.0	-		
			4.5–5.5	0.70 x V _{CC}	-	0.70 x V _{CC}	-		
V _{IL}	LOW Level Input Voltage		1.65–1.95	-	0.35 x V _{CC}	-	0.35 x V _{CC}	V	
			2.3–2.7	-	0.7	-	0.7		
			3.0-3.6	-	0.8	-	0.8		
			4.5–5.5	-	0.30 x V _{CC}	-	0.30 x V _{CC}	-	
V _{OH}	High-Level Output Voltage	$ \begin{array}{c} V_I = V_{IH} \mbox{ or } V_{IL} \\ I_{OH} = -100 \ \mu A \\ I_{OH} = -4 \ m A \\ I_{OH} = -8 \ m A \\ I_{OH} = -12 \ m A \\ I_{OH} = -12 \ m A \\ I_{OH} = -12 \ m A \\ I_{OH} = -24 \ m A \\ I_{OH} = -24 \ m A \\ I_{OH} = -32 \ m A \\ I_{OL} = -32 \ m A \\ I_{OL} = 100 \ \mu A \\ I_{OL} = 4 \ m A \\ I_{OL} = 12 \ m A \\ I_{OL} = 12 \ m A \\ I_{OL} = 16 \ m A \\ I_{OL} = 24 \ m A \end{array} $	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5 1.65 to 5.5 1.65 2.3 2.7 3.0 3.0	V _{CC} - 0.1 1.29 1.8 2.2 2.4 2.2 3.7 - - - - - - - -	- - - - - 0.1 0.24 0.3 0.4 0.4 0.55	V _{CC} - 0.1 1.29 1.8 2.2 2.4 2.2 3.7 - - - - - - -	- - - - - - - 0.1 0.24 0.3 0.4 0.4 0.55	V V	
l _l	Input Leakage Current	I _{OL} = 32 mA V _I = 0 to 5.5 V	4.5 3.6	_	0.6 ±5.0	_	0.6 ±5.0	μA	
I _{OFF}	Power Off Leakage Current	$V_{\rm I} = 5.5 \text{ V or}$ $V_{\rm O} = 5.5 \text{ V}$	0	_	±3.0 10	-	±3.0 10	μΑ	
Icc	Quiescent Supply Current	$V_{l} = 5.5 \text{ V or GND}$	3.6	-	10	-	10	μA	
ΔI_{CC}	Increase in I _{CC} per Input	V _{IH} = V _{CC} – 0.6 V	2.3 to 3.6	-	500	-	500	μA	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

				$T_A = -40 \ ^\circ C$ to +85 $^\circ C$		$T_A = -40 \text{ °C to } +85 \text{ °C}$ $T_A = -40 \text{ °C to } +125 \text{ °C}$		c to +125 °C	
Symbol	Parameter	Test Condition	V _{CC} (V)	Min	Max	Min	Мах	Unit	
t _{PLH} , t _{PHL}	Propagation Delay, Input to Output	See Figures 3 and 4	1.65 to 1.95	-	10.3	-	10.3	ns	
			2.3 to 2.7	-	6.6	-	6.6		
			2.7	-	6.2	-	6.2		
			3.0 to 3.6	-	5.5	-	5.5		
			4.5 to 5.5	-	4.2	-	4.2		

AC ELECTRICAL CHARACTERISTICS

				T _A = -40 °C	C to +85 °C	T _A = -40 °C	C to +125 °C	
Symbol	Parameter	Test Condition	V _{CC} (V)	Min	Max	Min	Max	Unit
t _{OSHL} , t _{OSLH}	Output to Output Skew		1.65 to 1.95	-	-	-	-	ns
			2.3 to 2.7	-	-	-	-	
			2.7	-	-	-	-	
			3.0 to 3.6	-	1.0	-	1.0	
			4.5 to 5.5	-	-	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

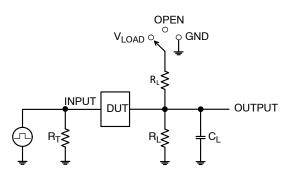
DYNAMIC SWITCHING CHARACTERISTICS

			T _A = +25 °C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OLP}	Dynamic LOW Peak Voltage	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V		0.8		V
	(Note 5)	V_{CC} = 2.5 V, C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V		0.6		V
V _{OLV}	Dynamic LOW Valley Voltage	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V		-0.8		V
	(Note 5)	V_{CC} = 2.5 V, C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V		-0.6		V

5. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Тур	Unit
C _{IN}	Input Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	7	pF
C _{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	10 MHz, V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	25	pF



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Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	V _{LOAD}
t _{PHZ} / t _{PZH}	GND

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

10%

tрн

 t_{PLH}

t_r = 2.5 ns

INPUT

OUTPUT

OUTPUT

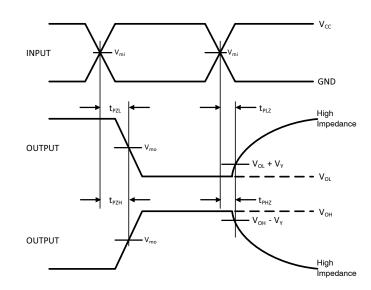


Figure	3.	Test	Circuit
iguio	υ.	1001	onoun

t_f = 2.5 ns

10%

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V_{ma}

t_{PLH}

 t_{PHL} Þ

Vcc

GND

V_{OH}

V_{OH}

 V_{OL}

-Vol

V _{CC} , V	R_{L}, Ω	C _L , pF	V _{LOAD}	v _m , v	V _Y , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V _{CC} /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V _{CC} /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	$2 \times V_{CC}$	V _{CC} /2	0.3

Figure 4. Switching Waveforms

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74LCX02DR2G	SOIC-14	LCX02G	2500 / Tape & Reel
MC74LCX02DTG	TSSOP-14	LCX 02	96 Units / Rail
MC74LCX02DTR2G	TSSOP-14	LCX 02	2500 / Tape & Reel
MC74LCX02DTR2G-Q*	TSSOP-14	LCX 02	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 *-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Capable.

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*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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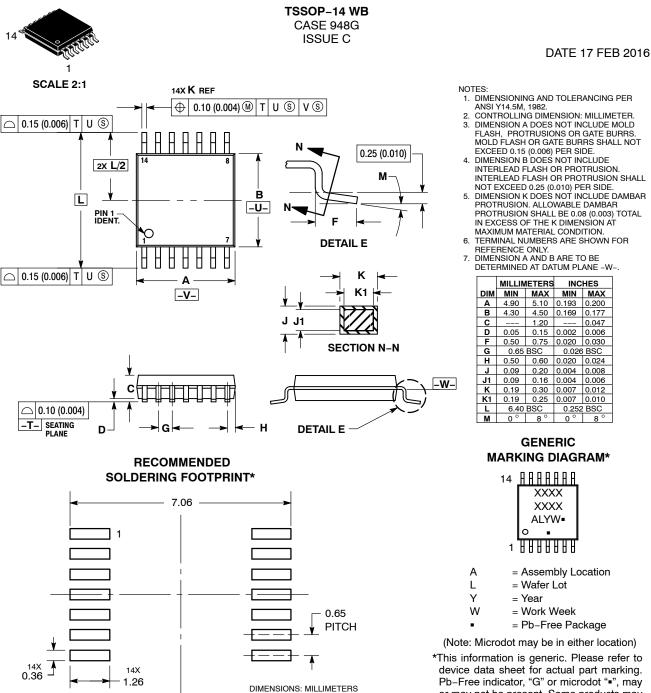
DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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